

UP-GWS02

Supplier: POKI / box size: 228(L)*181(W)*76(H) mm

Package Drop Test Report

Report NO: 17D030009



Summary	<p><input checked="" type="checkbox"/> Pass</p> <p><input type="checkbox"/> Fail</p> <p>Note : There is/are ____ defect(s) not list in the report, please check it in the DTS Website.</p> <p><input type="checkbox"/> Pass with Deviation</p> <p>Comment: _____</p>
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Issue date

2017-03-24

QE Manager

KJ Wang

Test Engineer

Ben Sun

Test item list

- | | |
|-------------------------------|---|
| 1. Configuration of EUT ----- | 2 |
| 2. Package drop test ----- | 3 |

Model Name: UP-GWS02		
1. Main Board	UP-CHT01 A0.3	
2. BIOS Ver.	UGW2AM03(20160604)	
3. CPU Type	Intel CPU.SOC.Cherry Trail-T3.x5-Z8350	
4. Chipset	Intel.SOC.Cherry Trail-T3.x5-Z8350	
5. OnboardMemory	DDR3L-SDRAM Hynix.H5TC8G63CMR-PBA/4GB	
6. Onboard eMMC	eMMC. Kingston.EMMC64G-M525-A51. 64GB	
7. Test Software	Windows 10 / Run PassMark Burn In Test 8.1 Pro	

Testing Result

Num	Test item list	Result	Remark
1	Package drop test	Pass	

Package Drop Test

Test Date: 03-23-2017

Test Product: UP-GWS02

Test Site: AAEON QE Dept.

Test Standard:

Reference ISTA PROJECT 1A

Test Equipment:

Drop Tester

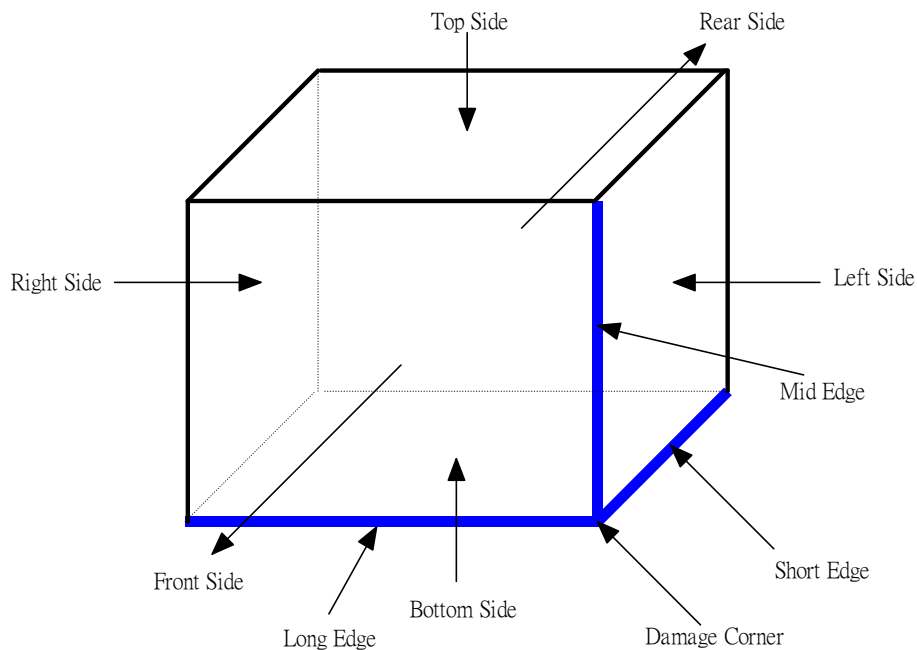
KING DESIGN Co. LTD.

Model: KD-128A

Serial Number: UU110099190

Test Condition:

1. Test Phase: One corner. Three edges. Six face
2. Test Cycle: 1 Cycle
3. Test High: 76cm
4. Test Weight: 0.66Kg
5. Sample Package: 1unit in double-package.
6. Test Drawing:



Test Result:

No issues were found after the packing drop test.